# Field Stop Trench IGBT, 30 A, 650 V

# FGAF30S65AQ

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop 4<sup>th</sup> generation of RC IGBTs offer the optimum performance for PFC applications and welder where low conduction and switching losses are essential.

#### Features

- Maximum Junction Temperature:  $T_J = 175^{\circ}C$
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage:  $V_{CE(Sat)} = 1.4 \text{ V} (Typ.) @ I_C = 30 \text{ A}$
- 100% of the Parts Tested for I<sub>LM</sub> (Note 1)
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- IGBT with Monolithic Reverse Conducting Diode
- This Device is Pb-Free and is RoHS Compliant

### **Typical Applications**

• PFC, Welder

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector to Emitter Voltage	V <sub>CES</sub>	650	V
Gate to Emitter Voltage Transient Gate to Emitter Voltage	V <sub>GES</sub>	±20 ±30	V
$ \begin{array}{ll} \mbox{Collector Current} & \mbox{@T}_{C} = 25^{\circ}\mbox{C} \\ \mbox{@T}_{C} = 100^{\circ}\mbox{C} \end{array} $	Ι <sub>C</sub>	60 30	A
Pulsed Collector Current (Note 1)	I <sub>LM</sub>	90	А
Pulsed Collector Current (Note 2)	I <sub>CM</sub>	90	Α
Diode Forward Current $@T_C = 25^{\circ}C$ $@T_C = 100^{\circ}C$	١ <sub>F</sub>	30 15	A
Pulsed Diode Maximum Forward Current	I <sub>FM</sub>	90	Α
Maximum Power Dissipation@T <sub>C</sub> = $25^{\circ}$ C @ T <sub>C</sub> = $100^{\circ}$ C	PD	83 42	W
Operating Junction / Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	–55 to +175	°C
Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5 seconds	ΤL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

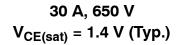
1.  $V_{CC}$  = 400 V,  $V_{GE}$  = 15 V,  $I_C$  = 90 A,  $R_G$  = 13  $\Omega$ , Inductive Load, 100% Tested

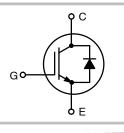




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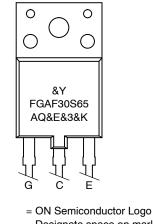








#### MARKING DIAGRAM



= Designate space on marking = 3-Digit Data Code = 2-Digit Lot Traceability Code

FGAF30S65AQ = Specific Device Code

&Y &E

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### ORDERING INFORMATION

Device	Package	Shipping
FGAF30S65AQ	TO-3PF-3L	30 Units / Rail

#### Table 1. THERMAL CHARACTERISTICS

Turn-on switching loss

Turn-off switching loss

Total switching loss

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case, for IGBT	$R_{ extsf{ heta}JC}$	1.8	°C/W
Thermal Resistance, Junction-to-Case, for Diode	$R_{ extsf{ heta}JC}$	2.3	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{ hetaJA}$	40	°C/W

## Table 2. ELECTRICAL CHARACTERISTICS (T\_J = 25°C unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTIC	•					
Collector-emitter breakdown voltage, gate-emitter short-circuited	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 1 mA	BV <sub>CES</sub>	650	-	-	V
Temperature Coefficient of Breakdown Voltage	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 1 mA	$\Delta {\rm BV}_{\rm CES} / \Delta {\rm T}_{\rm J}$	_	0.5	-	V/°C
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 650 V$	I <sub>CES</sub>	_	-	250	μA
Gate leakage current, collector-emitter short-circuited	$V_{GE}$ = 20 V, $V_{CE}$ = 0 V	I <sub>GES</sub>	-	-	±400	nA
ON CHARACTERISTIC						
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$ , $I_C = 30$ mA	V <sub>GE(th)</sub>	2.6	5.3	6.6	V
Collector-emitter saturation voltage	$V_{GE}$ = 15 V, I <sub>C</sub> = 30 A $V_{GE}$ = 15 V, I <sub>C</sub> = 30 A, T <sub>J</sub> = 175°C	V <sub>CE(sat)</sub>	-	1.4 1.7	2.1 -	V
DYNAMIC CHARACTERISTIC				U.		
Input capacitance	V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V, f = 1 MHz	C <sub>ies</sub>	-	1959	-	pF
Output capacitance		C <sub>oes</sub>	-	29	-	
Reverse transfer capacitance		C <sub>res</sub>	-	8	-	
Gate charge total	$V_{CE}$ = 400 V, $I_C$ = 30 A, $V_{GE}$ = 15 V	Qg	-	58	-	nC
Gate to emitter charge	1	Q <sub>ge</sub>	-	13	-	
Gate to collector charge		Q <sub>gc</sub>	-	17	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn–on delay time	$T_{\rm J} = 25^{\circ}{\rm C}$	t <sub>d(on)</sub>	-	17.6	-	ns
Rise time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 7.5 \text{ A}$ $R_{g} = 13 \Omega$	t <sub>r</sub>	-	6	-	
Turn-off delay time	V <sub>GE</sub> = 15 V	t <sub>d(off)</sub>	-	97	-	
Fall time	Inductive Load	t <sub>f</sub>	-	44	-	
Turn–on switching loss	1	Eon	-	295	-	μJ
Turn–off switching loss	1	E <sub>off</sub>	-	82	-	
Total switching loss		E <sub>ts</sub>	_	377	-	
Turn-on delay time	$T_J = 25^{\circ}C$	t <sub>d(on)</sub>	_	18	-	ns
Rise time	$V_{CC}$ = 400 V, I <sub>C</sub> = 15 A R <sub>g</sub> = 13 $\Omega$	t <sub>r</sub>	_	11	-	]
Turn-off delay time	V <sub>GE</sub> = 15 V	t <sub>d(off)</sub>	_	92	-	
Fall time	Inductive Load	t <sub>f</sub>	-	24	-	
					1	

515

140

655

μJ

-

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 $\mathsf{E}_{\mathsf{on}}$ 

 $\mathsf{E}_{\mathsf{off}}$ 

 $\mathsf{E}_{\mathsf{ts}}$ 

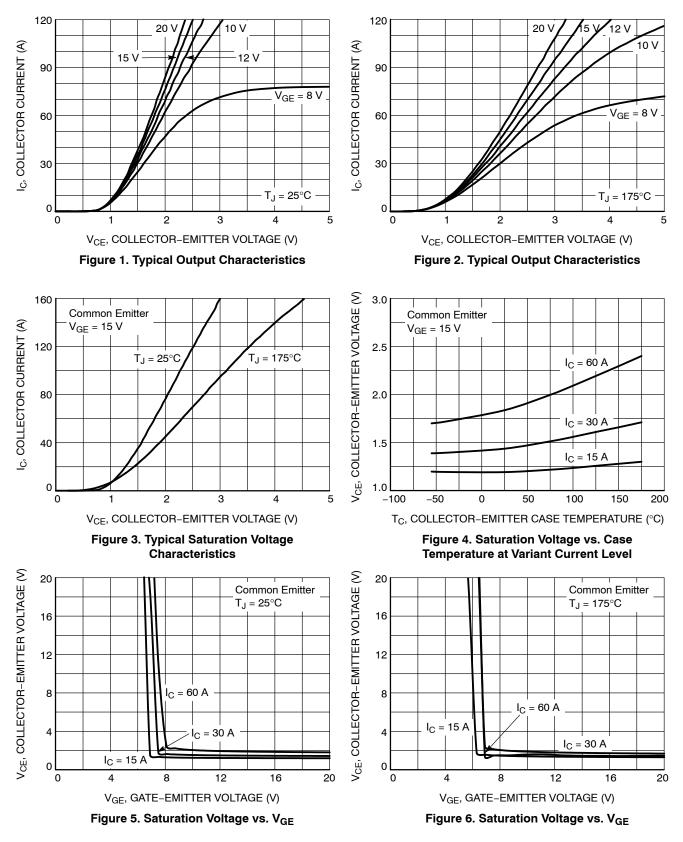
### Table 2. ELECTRICAL CHARACTERISTICS (T\_J = $25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
SWITCHING CHARACTERISTIC, IND	UCTIVE LOAD					
Turn–on delay time	T <sub>J</sub> = 175°C	t <sub>d(on)</sub>	-	17.6	-	ns
Rise time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 7.5 \text{ A}$	t <sub>r</sub>	-	6.4	-	1
Turn-off delay time	—— R <sub>g</sub> = 13 Ω V <sub>GE</sub> = 15 V	t <sub>d(off)</sub>	-	110	-	1
Fall time	Inductive Load	t <sub>f</sub>	-	56	-	1
Turn–on switching loss		Eon	-	442	-	μJ
Turn-off switching loss		E <sub>off</sub>	-	145	-	1
Total switching loss		E <sub>ts</sub>	-	587	-	1
Turn–on delay time	T <sub>J</sub> = 175°C	t <sub>d(on)</sub>	-	18	-	ns
Rise time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 15 \text{ A}$	t <sub>r</sub>	-	12	-	1
Turn-off delay time	—— R <sub>g</sub> = 13 Ω V <sub>GE</sub> = 15 V	t <sub>d(off)</sub>	-	104	-	1
Fall time	Inductive Load	t <sub>f</sub>	-	48	-	1
Turn–on switching loss		E <sub>on</sub>	-	741	-	μJ
Turn-off switching loss	_	E <sub>off</sub>	-	274	-	1
Total switching loss	_	E <sub>ts</sub>	-	1015	-	1
DIODE CHARACTERISTIC	•	-	-	-	-	
			I			

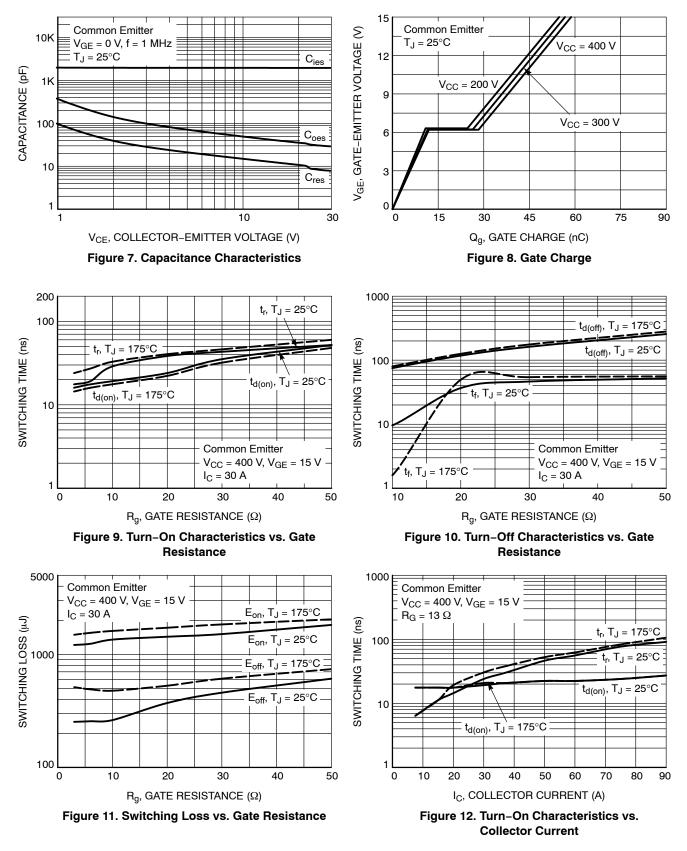
Forward Voltage	I <sub>F</sub> = 15 A	V <sub>F</sub>	-	1.3	1.6	V
	I <sub>F</sub> = 15 A, T <sub>J</sub> = 175°C		-	1.3	-	
Reverse Recovery Energy	$I_F = 15 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}$	E <sub>rec</sub>	-	239	-	μJ
Diode Reverse Recovery Time	$I_F = 15 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}$ $I_F = 15 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \text{ T}_J = 175^\circ\text{C}$	T <sub>rr</sub>	-	267 347	-	nS
Diode Reverse Recovery Charge	$I_F = 15 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}$ $I_F = 15 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \text{ T}_J = 175^\circ\text{C}$	Q <sub>rr</sub>	_	1135 1873	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

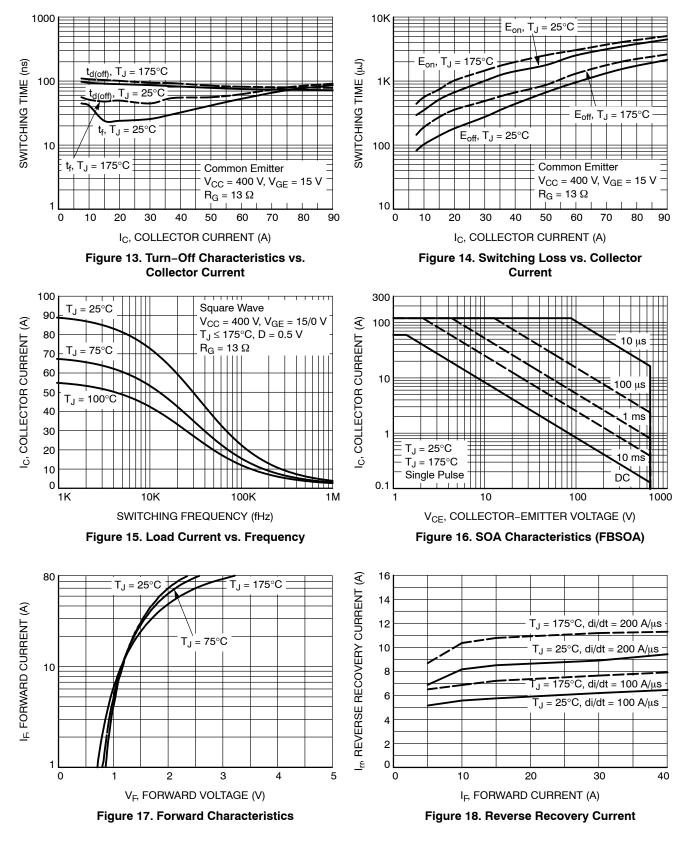
#### **TYPICAL CHARACTERISTICS**



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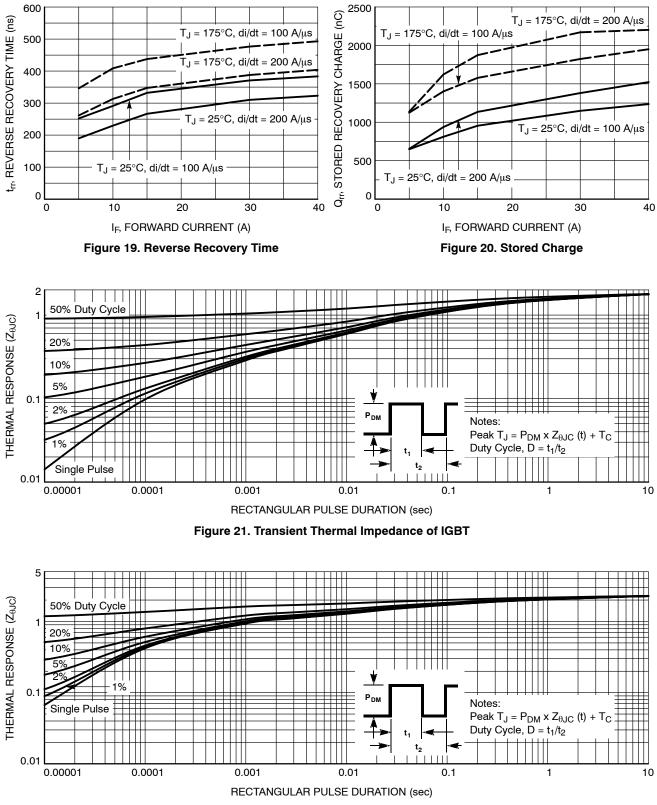
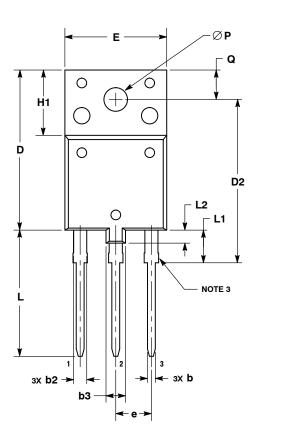
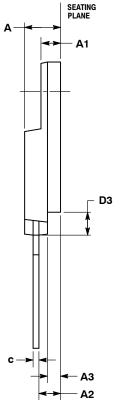


Figure 22. Transient Thermal Impedance of Diode

#### PACKAGE DIMENSIONS

TO-3PF-3L CASE 340AH ISSUE A





NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009. 2. CONTROLLING DIMENSION: MILLIMETERS.

 CONTROLLING DIMENSION: MILLIMETERS.
CONTOUR UNCONTROLLED IN THIS AREA (6 PLACES).
DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE TO BE MEA-SURED AT THE OUTERMOST EXTREME OF THE PLASTIC BODY.
DIMENSION b2 DOES NOT INCLUDE DAMBAR PROTRUSION.

5. DIMENSION b2 DOES NOT INCLUDE DAMBAR PROTRUSION. LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 2.20.

	MILLIMETERS		
DIM	MIN	MAX	
Α	5.30	5.70	
A1	2.80	3.20	
A2	3.10	3.50	
A3	1.80	2.20	
b	0.65	0.95	
b2	1.90	2.15	
b3	3.80	4.20	
C	0.80	1.10	
D	24.30	24.70	
D2	24.70	25.30	
D3	3.30	3.70	
E	15.30	15.70	
е	5.35	5.55	
H1	9.80	10.20	
L	19.10	19.50	
L1	4.80	5.20	
L2	1.90	2.20	
Ρ	3.40	3.80	
Q	4.30	4.70	

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